

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>RONGYAO MA</td> <td>08/28/2013</td> </tr> <tr> <td>TIESHENG LI</td> <td>08/28/2013</td> </tr> <tr> <td>LEI ZHANG</td> <td>08/28/2013</td> </tr> <tr> <td>DAPING FU</td> <td>08/28/2013</td> </tr> </tbody> </table>		Name	Execution Date	RONGYAO MA	08/28/2013	TIESHENG LI	08/28/2013	LEI ZHANG	08/28/2013	DAPING FU	08/28/2013
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<table border="1"> <tr> <td>Name:</td> <td>CHENGDU MONOLITHIC POWER SYSTEMS, INC.</td> </tr> <tr> <td>Street Address:</td> <td>NO. 8, KEXIN ROAD</td> </tr> <tr> <td>Internal Address:</td> <td>WEST ZONE OF HI-TECH ZONE</td> </tr> <tr> <td>City:</td> <td>CHENGDU</td> </tr> <tr> <td>State/Country:</td> <td>CHINA</td> </tr> </table>		Name:	CHENGDU MONOLITHIC POWER SYSTEMS, INC.	Street Address:	NO. 8, KEXIN ROAD	Internal Address:	WEST ZONE OF HI-TECH ZONE	City:	CHENGDU	State/Country:	CHINA
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<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14066626</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14066626						
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CORRESPONDENCE DATA											
<p>Fax Number:</p> <p>Email: assignmentconfirmations@perkinscoie.com</p> <p><i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i></p> <p>Correspondent Name: PERKINS COIE LLP</p> <p>Address Line 1: P.O. BOX 1247</p> <p>Address Line 2: PATENT-SEA</p> <p>Address Line 4: SEATTLE, WASHINGTON 98111-1247</p>											
ATTORNEY DOCKET NUMBER:	38616-8303.US00										
NAME OF SUBMITTER:	JORDAN HUNTLEY										
Signature:	/Jordan Huntley/										

Date:

02/03/2014

Total Attachments: 6

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ASSIGNMENT BY INVENTORS

This Assignment is by the following inventors (the "Assignor(s)"):

Rongyao Ma, having the mailing address of No.8, Kexin Road, West Zone of Hi-tech Zone, Chengdu, Sichuan, 610051, PEOPLE'S REPUBLIC OF CHINA;

Tiesheng Li, having the mailing address of 6343 Prospect Road, San Jose, CA, 95129, UNITED STATES;

Lei Zhang, having the mailing address of No. 226 Shuanglin Road, Chengdu, Sichuan, 610000, PEOPLE'S REPUBLIC OF CHINA; and

Daping Fu, having the mailing address of No.8, Kexin Road, West Zone of Hi-tech Zone, Chengdu, Sichuan, 610051, PEOPLE'S REPUBLIC OF CHINA.

The Assignor(s) have invented one or more certain inventions described in a Patent application for Letters Patent of the United States entitled JUNCTION FIELD EFFECT TRANSISTORS AND ASSOCIATED FABRICATION METHODS (the "Application"), executed concurrently herewith and naming the Assignors as inventors. The Assignors authorize the Assignee, identified below, or its representatives to insert the application number of the Application 14/066,626 when known.

Chengdu Monolithic Power Systems, Inc., a Corporation of China having its principal place of business at No.8, Kexin Road, West Zone of Hi-tech Zone, Chengdu, Sichuan, P.R. China ("Assignee"), desires to acquire the entire right, title and interest in and to the Invention(s) and the Application, and in and to any patents (collectively, "Patents") that may be granted for the Invention(s) in the United States or in any foreign countries.

For valuable consideration, the receipt and sufficiency of which Assignor(s) acknowledge, Assignor(s) hereby sell, assign, and transfer to Assignee, its successors, legal representatives and assigns, the entire right, title and interest in and to: the

Invention(s), the Application, and any Patents; any divisions, continuations, and continuations-in-part of the Application and any other application claiming priority rights from the Application; any reissues, reexaminations, or extensions of any and all Patents; the right to file foreign applications directly in the name of Assignee; and the right to claim priority rights deriving from the Application (collectively, the "Rights"). Assignor(s) warrant that Assignor(s) own the Rights, and that the Rights are unencumbered. Assignor(s) also agree to not sign any writing or do any act conflicting with this assignment, and, without further compensation, sign all documents and do such additional acts as Assignee deems necessary or desirable to: perfect Assignee's enjoyment of the Rights; conduct proceedings regarding the Rights, including any litigation or interference proceedings; or perfect or defend title to the Rights. Assignor(s) request the Commissioner of Patents to issue any Patent of the United States that may be issued on the Invention(s) to Assignee. This Assignment may be executed in counterparts.

Rongyao Ma

Rongyao Ma

Date: 07.10.2013

Jing Yang

Witness -- Signed Name

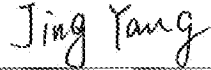
Jing Yang

Witness -- Printed Name



Tiesheng Li

Date: 8/28/13

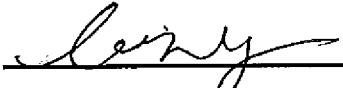


Witness – Signed Name



Witness – Printed Name

Date: 8/28/13



Lei Zhang

Date: 12/6/2013

On this 6th day of Dec, 2013, before me personally came

Lei Zhang, to me known to be the individual described in and who
executed the foregoing instrument, and acknowledged execution of the same.



Witness Signature

YANG XIANG

Witness Printed Name

Date: 8/28/2013

Daping Fu

Daping Fu

Jing Yang

Witness – Signed Name

Jing Yang

Witness – Printed Name